

PXN012-60QL

N-channel 60 V, 11.5 mOhm, logic level Trench MOSFET in MLPAK33 8 July 2021

Product data sheet

1. General description

General purpose, 42 A rated, logic level N-channel enhancement mode Power MOSFET in MLPAK33 package.

2. Features and benefits

- Logic level compatibility •
- Trench MOSFET technology •
- Thermally efficient package in a small form factor (3.3 mm x 3.3 mm footprint)

3. Applications

- Secondary side synchronous rectification •
- DC-to-DC converters
- Motor drive
- LED lighting
- Load switching •
- Auxiliary control
- Fan control

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 150 °C		-	-	60	V
I _D	drain current	V _{GS} = 10 V; T _{sp} = 25 °C; <u>Fig. 2</u>		-	-	42	А
P _{tot}	total power dissipation	T _{sp} = 25 °C; <u>Fig. 1</u>		-	-	34.7	W
Tj	junction temperature			-55	-	150	°C
Static chara	acteristics						
R _{DSon}	drain-source on-state	V _{GS} = 10 V; I _D = 10 A; T _j = 25 °C; <u>Fig. 9</u>		-	9.8	11.5	mΩ
	resistance	V _{GS} = 4.5 V; I _D = 10 A; T _j = 25 °C; <u>Fig. 9</u>		-	14	17.6	mΩ
Dynamic ch	naracteristics						
Q _{GD}	gate-drain charge	I_D = 10 A; V_{DS} = 30 V; V_{GS} = 4.5 V;		-	4.3	-	nC
Q _{G(tot)}	total gate charge	T _j = 25 °C; <u>Fig. 11</u> ; <u>Fig. 12</u>		-	9.64	-	nC
Avalanche	ruggedness						
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	I _D = 3.5 A; T _{j(init)} = 25 °C; unclamped	[1]	-	-	90	mJ

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Source-drain d	iode						
Qr		$ I_S = 10 \text{ A}; \text{ d}_S/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ V_{DS} = 30 \text{ V}; \text{ T}_j = 25 ^\circ\text{C}; \text{ Fig. 15} $	[2]	-	13	-	nC

[1] Protected by 100% test

[2] includes capacitive recovery

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	1 2 3 4	
2	S	source	رف ف ف ف	
3	S	source		D
4	G	gate		
5	D	drain		G C C C C C C C C C C C C C C C C C C C
6	D	drain	Цеее	mbb076 S
7	D	drain		
8	D	drain	MLPAK33 (SOT8002-1)	

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PXN012-60QL	MLPAK33	plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1		

7. Marking

Table 4. Marking codes	
Type number	Marking code
PXN012-60QL	7AB

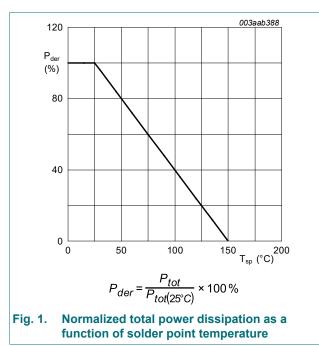
8. Limiting values

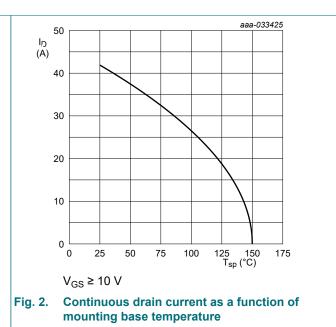
Table 5. Limiting values

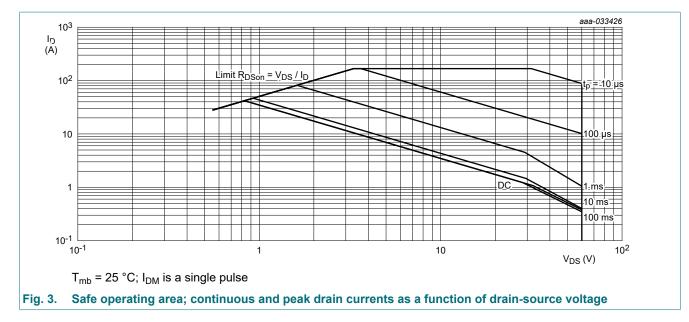
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 150 °C		-	60	V
V _{GS}	gate-source voltage			-20	20	V
P _{tot}	total power dissipation	T _{sp} = 25 °C; <u>Fig. 1</u>		-	34.7	W
I _D	drain current	V _{GS} = 10 V; T _{sp} = 25 °C; <u>Fig. 2</u>		-	42	А
		V _{GS} = 10 V; T _{sp} = 100 °C; <u>Fig. 2</u>		-	26	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{sp} = 25 \ ^{\circ}C$; Fig. 3		-	168	А
T _{stg}	storage temperature			-55	150	°C
Tj	junction temperature			-55	150	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drai	in diode	1	I	I		
I _S	source current	T _{sp} = 25 °C		-	29	А
I _{SM}	peak source current	pulsed; t _p ≤ 10 µs; T _{sp} = 25 °C		-	168	А
Avalanche	ruggedness					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	I_D = 3.5 A; $T_{j(init)}$ = 25 °C; unclamped	[1]	-	90	mJ
I _{AS}	non-repetitive avalanche current	T _{j(init)} = 25 °C	[1]	-	3.5	A

[1] Protected by 100% test

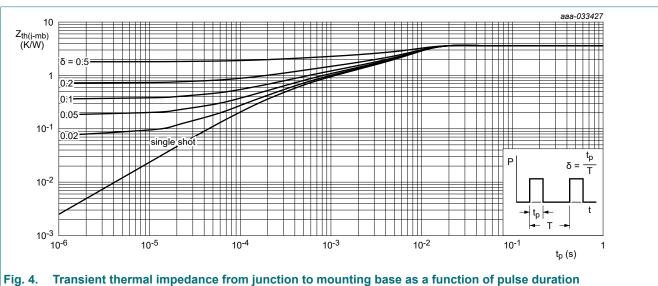






9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point	<u>Fig. 4</u>	-	3	3.6	K/W



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	teristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _i = 25 °C	60	70	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _i = -55 °C	-	64	-	V
V _{GS(th)}	gate-source threshold	I _D = 1 mA; V _{DS} =V _{GS} ; T _i = 25 °C; <u>Fig. 8</u>	1.5	1.9	2.5	V
	voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _i = 150 °C	0.9	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}$	-	-	2.9	V
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 150 °C	-	-4.7	-	mV/K
I _{DSS}	drain leakage current	V _{DS} = 60 V; V _{GS} = 0 V; T _j = 25 °C	-	0.01	1	μA
		V _{DS} = 60 V; V _{GS} = 0 V; T _j = 150 °C	-	-	500	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state	V _{GS} = 10 V; I _D = 10 A; T _j = 25 °C; <u>Fig. 9</u>	-	9.8	11.5	mΩ
resistance	resistance	V _{GS} = 10 V; I _D = 10 A; T _j = 150 °C; <u>Fig. 10</u>	-	-	20	mΩ
		V _{GS} = 4.5 V; I _D = 10 A; T _j = 25 °C; <u>Fig. 9</u>	-	14	17.6	mΩ
		V _{GS} = 4.5 V; I _D = 10 A; T _j = 150 °C; Fig. 10	-	-	30	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	-	1.66	-	Ω
Dynamic cha	racteristics					
Q _{G(tot)}	total gate charge	$ I_D = 10 \text{ A}; V_{DS} = 30 \text{ V}; V_{GS} = 4.5 \text{ V}; $	-	9.64	-	nC
		$ I_D = 10 \text{ A}; V_{DS} = 30 \text{ V}; V_{GS} = 10 \text{ V}; T_j = 25 \text{ °C}; Fig. 11; Fig. 12 $	-	18.77	-	nC
		$ I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 4.5 \text{ V}; $	-	9.54	-	nC
Q _{GS}	gate-source charge	I_D = 10 A; V_{DS} = 30 V; V_{GS} = 4.5 V;	-	3	-	nC
Q _{GS(th)}	pre-threshold gate- source charge	T _j = 25 °C; <u>Fig. 11; Fig. 12</u>	-	1.6	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	1.4	-	nC
Q _{GD}	gate-drain charge		-	4.3	-	nC
V _{GS(pl)}	gate-source plateau voltage	I_D = 10 A; V_{DS} = 30 V; T_j = 25 °C; Fig. 11; Fig. 12	-	3.1	-	V
C _{iss}	input capacitance	V _{DS} = 30 V; V _{GS} = 0 V; f = 1 MHz;	-	957	-	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 13</u>	-	386	-	pF
C _{rss}	reverse transfer capacitance		-	31	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 30 \text{ V}; \text{ R}_{L} = 3 \Omega; \text{ V}_{GS} = 4.5 \text{ V};$	-	8.8	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	18.5	-	ns
t _{d(off)}	turn-off delay time] – – – – – – – – – – – – – – – – – – –	-	12.2	-	ns
t _f	fall time	1		10.9		ns

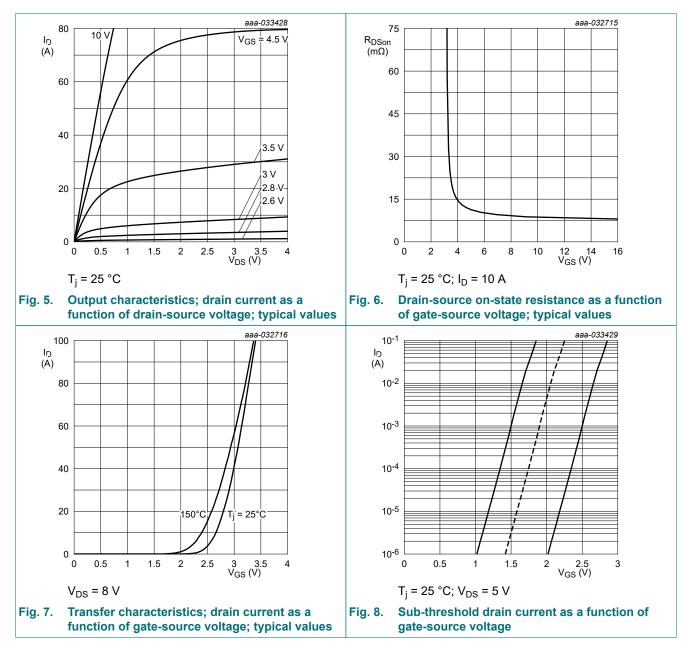
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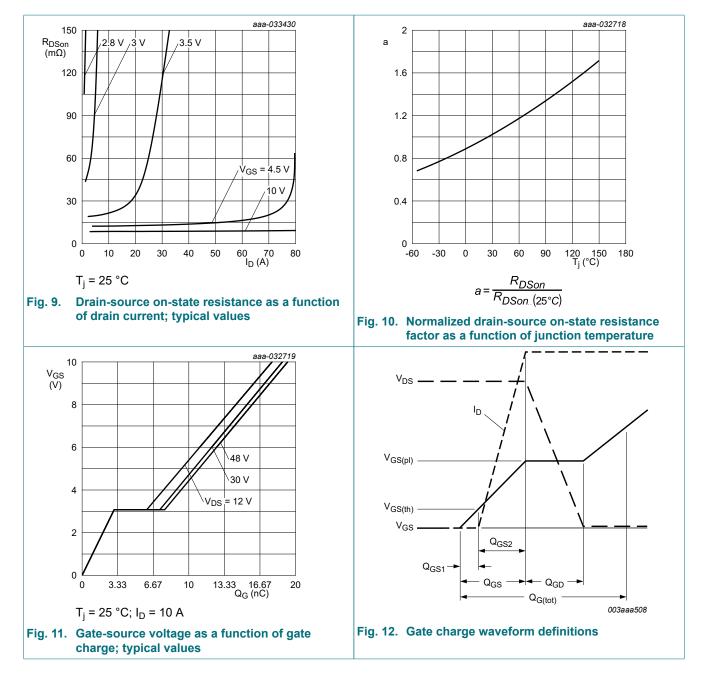
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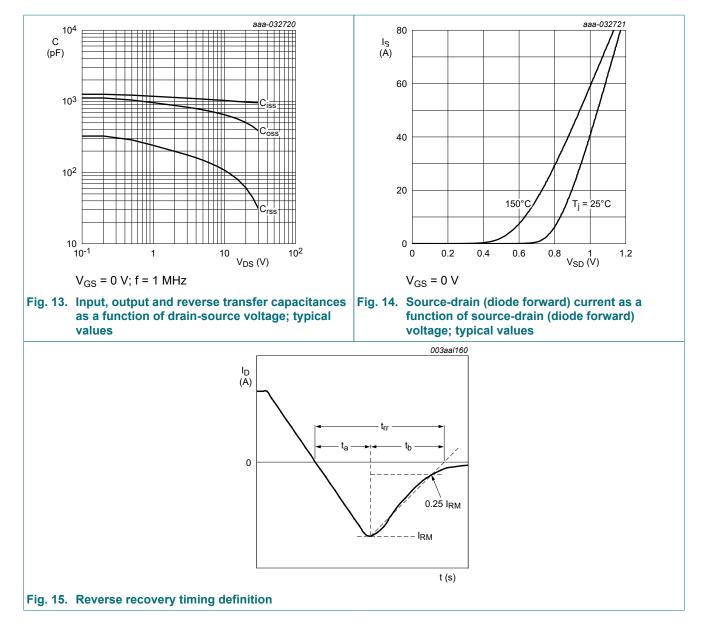
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Symbol	Parameter	Conditions		Min	Тур	Мах	Unit	
Q _{oss}	output charge	V _{GS} = 0 V; V _{DS} = 30 V; f = 1 MHz; T _j = 25 °C		-	18	-	nC	
Source-drain diode								
V _{SD}	source-drain voltage	I_{S} = 10 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 14</u>		-	0.82	1.2	V	
t _{rr}	reverse recovery time	I_{S} = 10 A; dI _S /dt = -100 A/µs; V _{GS} = 0 V;		-	22.1	-	ns	
Q _r	recovered charge	V _{DS} = 30 V; T _j = 25 °C; <u>Fig. 15</u>		-	13	-	nC	

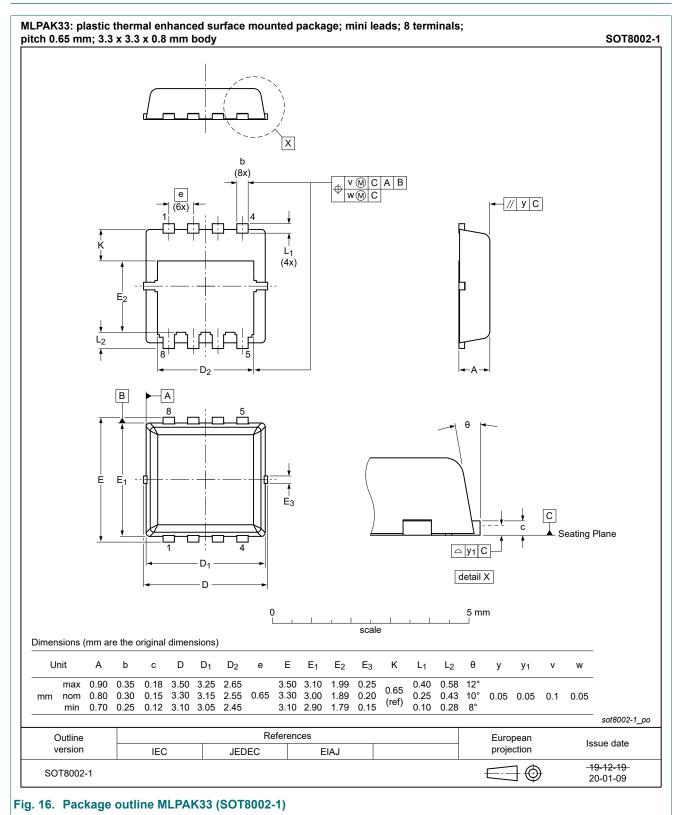
[1] includes capacitive recovery



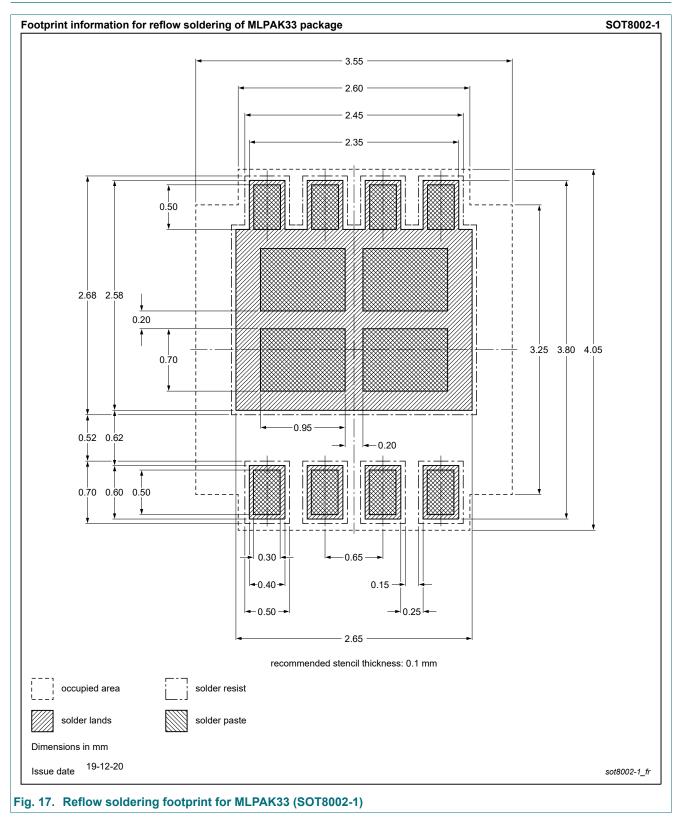




11. Package outline



12. Soldering



13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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